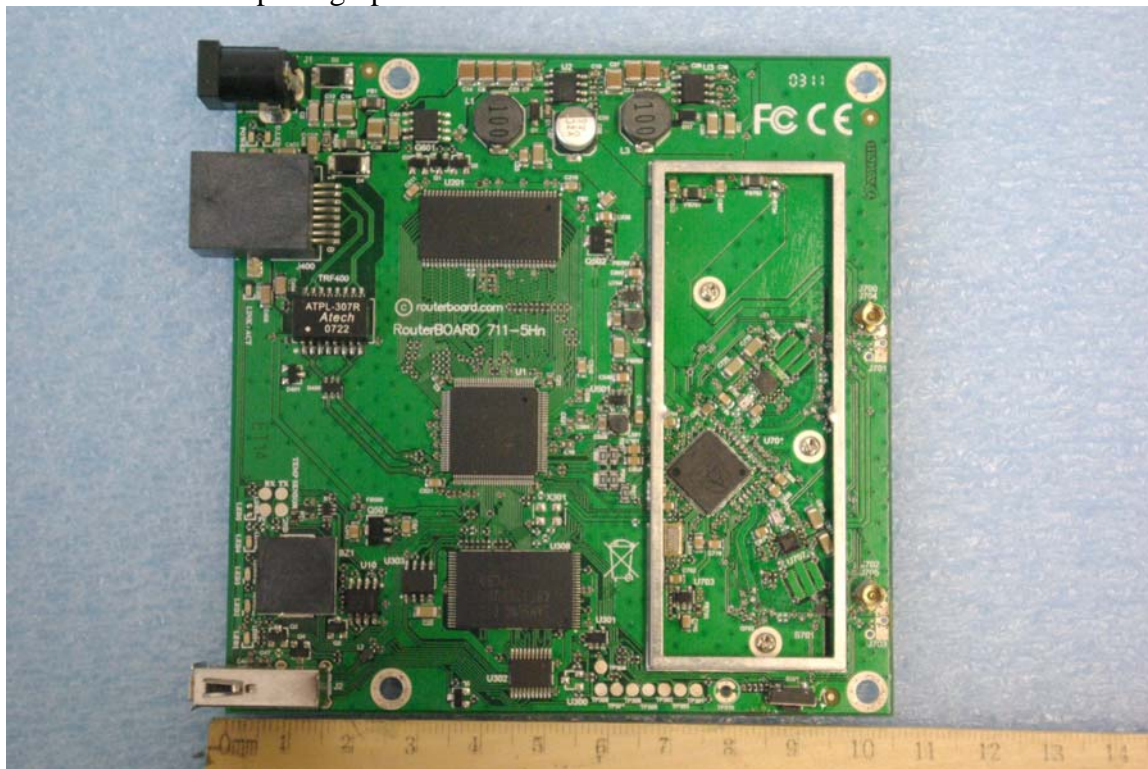


Internal photographs of equipment under test (inside enclosure)



Shield removed for photograph



Back side of EUT PCB (heat sink in place – No components placed under heat sink)

